| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
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| L1 | 3 | ("20060113523" "5877080" "6709753" "7193237" "20030226996" "20050121675" "20060076556" "20060231832" "20060234335" "20060269876" "20070090376" "20070093078" "5114757" "5286572" "6348407" "6372665" "6468898" "6943451" "7119442" "20020024150" "20020048931" "20020130375" "2003001240" "20030013292" "20030155657" "20040066679" "20050064726" "20050200021" "20060141778" "20070049044" "5623476" "6703302" "6716529" "6903006" "6933601" "6998308" "7211502" "20020025431" "20020173138" "20040087058" "20040201011" "20040238941" "20040241980" "20050101709" "20050215068" "20050260786" "20060270066" "20070045613"). pn. and (silsesquioxane near9 skeleton) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/06 14:15 |
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| EAST Search history | | | | | | | |
|---------------------|---------|--|--|------|----|------------------|--|
| L3 | | "7026231" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/06 14:20 | |
| S1 | 2 | ("20020012083" "20040118520" "20 050202348" "20050287697" "20060 081880" "7026231").PN. and (organic near semiconductor) and (substrate or wafer or base or carrier) and (insulat\$4 or oxide or dielectric) and (conduct\$4 or metal) and silsesquioxane | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:24 | |
| S2 | 1 | ("20020012083" "20040118520" "20 050202348" "20050287697" "20060 081880" "7026231").PN. and (organic near semiconductor) and (substrate or wafer or base or carrier) and (insulat\$4 or oxide or dielectric) and (conduct\$4 or metal) and (silsesquioxane near skeleton) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR . | ON | 2007/06/05 12:25 | |
| S3 | | (organic near semiconductor) and (substrate or wafer or base or carrier) and (insulat\$4 or oxide or dielectric) and (conduct\$4 or metal) and (silsesquioxane near skeleton) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:27 | |
| S4 | 4935537 | Kubota et al .inv. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:28 | |
| S5 | 40055 | Kubota.inv. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:30 | |
| S6 | 0 | makotokubota.inv. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:29 | |

| S7 | . 0 | makotonearkubota.inv. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:29 |
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| \$8 | 0 | makotonearkubota | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:29 |
| S9 | 175995 | makoto.inv. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR . | ON | 2007/06/05 12:29 |
| S10 | 50 | Kubota.inv. and (organic near semiconductor) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:31 |
| S11 | 0 | Kubota.inv. and (organic near semiconductor) and electrode and (substrate or wafer or carrier or base) and (dielectric or oxide or insulat\$4) and (conduct\$4 or metal) and sisesquioxane | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:32 |
| S12 | 5 | Kubota.inv. and (organic near semiconductor) and electrode and (substrate or wafer or carrier or base) and (dielectric or oxide or insulat\$4) and (conduct\$4 or metal) and silsesquioxane | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:39 |
| S13 | 43 | (silsesquioxane near skeleton) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR - | ON . | 2007/06/05 12:40 |

| S14 | 9 | (silsesquioxane near skeleton) and (organic near semiconductor) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:40 |
|-----|---|---|--|----|----|------------------|
| S15 | 9 | (silsesquioxane near skeleton) and (organic near semiconductor) and (insulat\$4 or oxide or dielectric) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:40 |
| S16 | 8 | (silsesquioxane near skeleton) and (organic near semiconductor) and (insulat\$4 or oxide or dielectric) and electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:41 |
| S17 | 8 | (silsesquioxane near skeleton) and (organic near semiconductor) and (insulat\$4 or oxide or dielectric) and electrode and (substrate or wafer or carrier or base) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:41 |
| S18 | 7 | (silsesquioxane near skeleton) and (organic near semiconductor) and (insulat\$4 or oxide or dielectric) and electrode and (substrate or wafer or carrier or base) and alkyl | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:41 |
| S19 | 7 | (silsesquioxane near skeleton) and (organic near semiconductor) and (insulat\$4 or oxide or dielectric) and electrode and (substrate or wafer or carrier or base) and alkyl and phenyl | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:41 |
| S20 | 6 | (silsesquioxane near skeleton) and (organic near semiconductor) and (insulat\$4 or oxide or dielectric) and electrode and (substrate or wafer or carrier or base) and alkyl and phenyl and copolymer | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/05 12:42 |